

# NCE P-Channel Enhancement Mode Power MOSFET

# Description

The NCE01P18L uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications. It is ESD protested.

# **General Features**

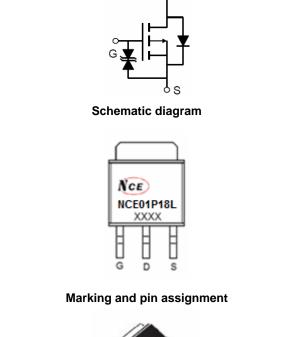
- V<sub>DS</sub> =-100V,I<sub>D</sub> =-18A
  R<sub>DS(ON)</sub> <100mΩ @ V<sub>GS</sub>=-10V (Typ:85mΩ)
- Super high dense cell design
- Advanced trench process technology
- Reliable and rugged
- High density cell design for ultra low On-Resistance

## Application

- Power management in notebook computer
- Portable equipment and battery powered systems

## 100% UIS TESTED!

**100% ΔVds TESTED!** 



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TO-251S top view

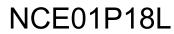
# **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE01P18L	NCE01P18L	TO-251S	-	-	-

# Absolute Maximum Ratings (T<sub>c</sub>=25<sup>°</sup>C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	-100	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι <sub>D</sub>	-18	А
Drain Current-Continuous(T <sub>C</sub> =100℃)	I <sub>D</sub> (100℃)	-12	A
Pulsed Drain Current	I <sub>DM</sub>	-72	A
Maximum Power Dissipation	PD	70	W
Derating factor		0.56	W/°C
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 150	°C





## **Thermal Characteristic**

Thermal Resistance, Junction-to-Case (Note 2)	$R_{ extsf{ heta}Jc}$	1.79	°C <b>/W</b>
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# Electrical Characteristics (T<sub>C</sub>=25<sup>°</sup>C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·	•	•			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =-250µA	-100	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-100V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±20	μA
On Characteristics (Note 3)	·	•	•			
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250µA	-1	-1.9	-3	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-16A	-	85	100	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =-50V,I <sub>D</sub> =-10A	5	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>		-	2100	-	PF
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ =-25V, $V_{GS}$ =0V,	-	590	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz	-	140	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	16	-	nS
Turn-on Rise Time	tr	V <sub>DD</sub> =-50V,I <sub>D</sub> =-16A	-	73	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	V <sub>GS</sub> =-10V,R <sub>GEN</sub> =9.1Ω	-	34	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	57	-	nS
Total Gate Charge	Qg	)/ 00)// 40A	-	61	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =-80V,I <sub>D</sub> =-16A,	-	14	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =-10V	-	29	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-18A	-	-	-1.2	V
Diode Forward Current (Note 2)	Is	-	-	-	-18	A
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, IF =-18A	-	88.3	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>	-	65.9	-	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- **3.** Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25  $^\circ\!\mathrm{C}$  ,V\_DD=-50V,V\_G=-10V,L=0.5mH,Rg=25 $\Omega$

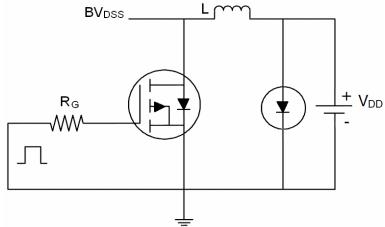


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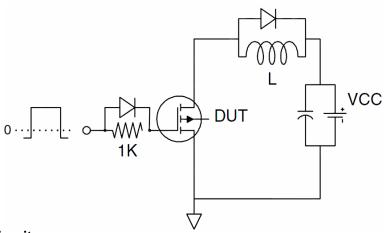




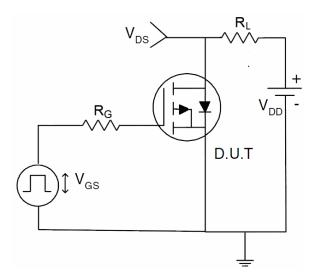
# Test Circuit 1) E<sub>AS</sub> Test Circuit



# 2) Gate Charge Test Circuit



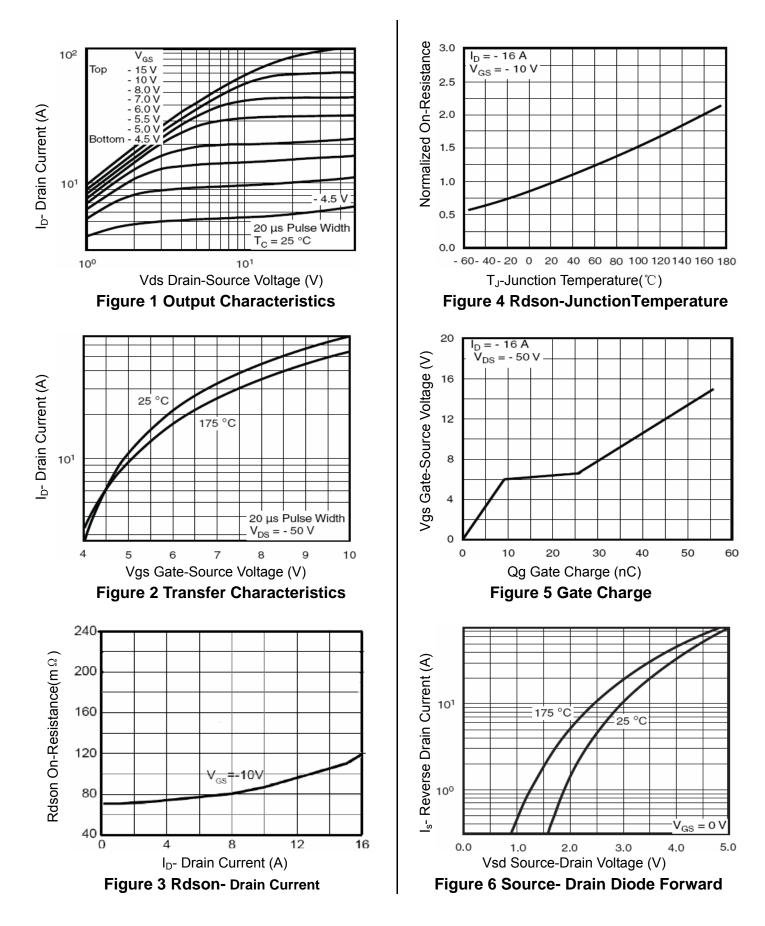
# 3) Switch Time Test Circuit







# **Typical Electrical and Thermal Characteristics (Curves)**





C Capacitance (nF)

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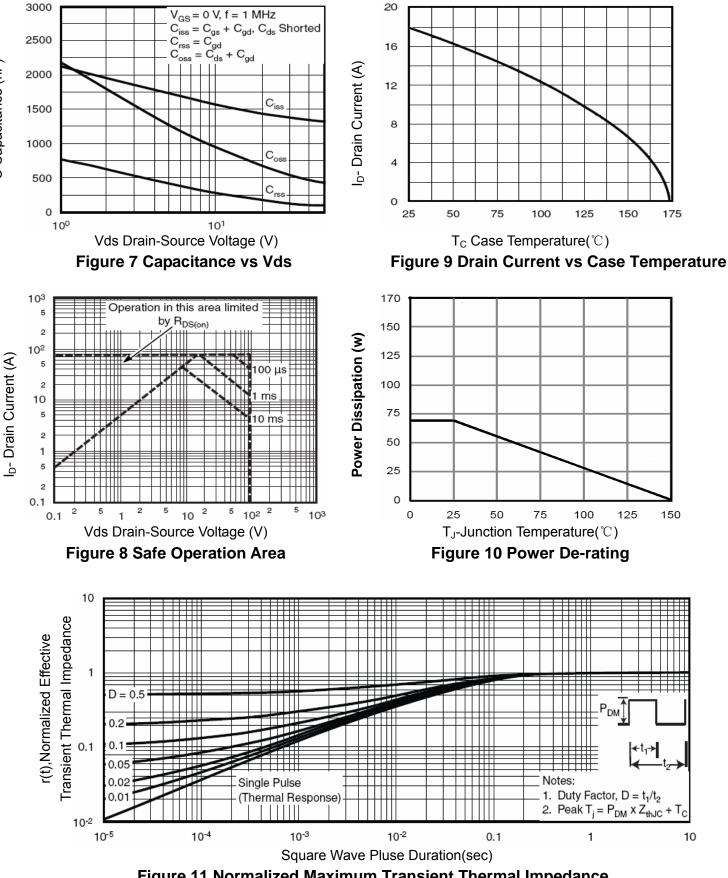


Figure 11 Normalized Maximum Transient Thermal Impedance

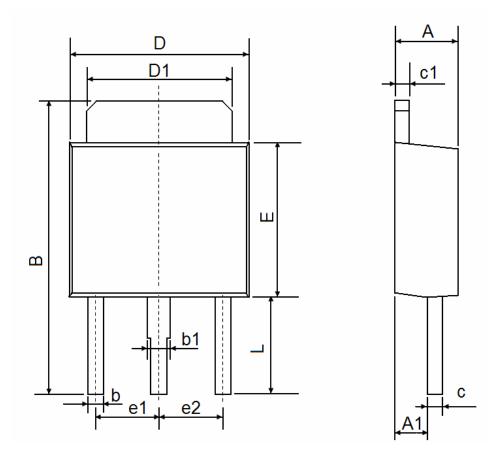
**Pb Free Product** 

NCE01P18L





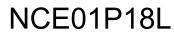
# **TO-251S Package Information**



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	2.250	2.350	0.089	0.093	
A1	1.150	1.250	0.045	0.049	
В	10.200	10.800	0.402	0.425	
b	0.550	0.650	0.022	0.026	
b1	0.750	0.850	0.030	0.033	
С	0.480	0.540	0.019	0.021	
c1	0.480	0.540	0.019	0.021	
D	6.400	6.600	0.252	0.260	
D1	5.250	5.350	0.207	0.211	
E	5.400	5.600	0.213	0.220	
e1	2.300 TYP		0.091 TYP		
e2	2.300 TYP		0.091 TYP		
L	3.300	3.700	0.130	0.146	







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